## Enhanced Second Generation (2G) High Temperature Superconducting (HTS) Wire for Electric Motor Applications

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## **Overview**

**Project Title:** Enhanced Second Generation (2G) High Temperature Superconducting (HTS) Wire for Electric Motor Applications

#### Timeline:

 Project Start Date:
 06/01/2017

 Budget Period 1 End Date<sup>1</sup>:
 05/31/2019

 Project End Date:
 05/31/2022

#### **Barriers and Challenges:**

- The Cost/Performance (\$/kA-m) of today's 2G HTS wire does not allow the development of economical highefficiency HTS-based machines.
- Innovative concepts and manufacturing technologies are needed to improve the wire Cost/Performance metric.

#### **AMO MYPP Connection:**

 Project is part of the Next Generation Electric Machines 2 portfolio which supports AMO's MYPP target 3.4: Increase the efficiency of targeted electric machines by 2-3% (a reduction in losses of 28 - 75%)

#### Project Budget and Costs:

Budget	DOE Share	Cost Share	Total	Cost Share %
Overall Budget	\$3,751,183	\$1,125,740	\$4,876,923	23%
Approved Budget (BP-1)	\$1,474,976	\$422,309	\$1,897,285	22%
Costs as of 3/31/19	\$1,200,709	\$360,275	\$1,560,985	23%

#### **Project Team and Roles:**

- American Superconductor Corporation (AMSC)
  - Exfoliation, irradiation and thick film development; R2R processing; coil fabrication
- Brookhaven Technology Group (BTG)
  - Co-development of key exfoliation technologies and processing
- Brookhaven National Laboratory (BNL)
  - Ion irradiation development and characterization
- University of Buffalo (UB)
  - Micro-structural analysis and characterization
- All partners are contributing a 20% cost share

(1) - BP1 was extended a year to accommodate the re-location of AMSC's manufacturing and R&D facility

# Project Objective(s)

#### The Challenge:

- Performance of today's "state-of-the-art" HTS wire is suppressed in the presence of magnetic fields, limiting its usefulness in *high-efficiency machine applications* targeted for around 65K operation
  - Current solutions (lower operation temperature, thick HTS layers, complex pinning structures, increased quantities of wire) add to system cost and decrease manufacturing yield
  - The development of cost competitive HTS machines that achieve a 2-3% increase in efficiency (a reduction in loses of 28-75%) requires improvement of the HTS wire in order to reduce the system cost and enable operation near LN<sub>2</sub> temperature

#### **Project Objective:**

• A 7-fold increase in critical current (*I*<sub>c</sub>) and a 50% reduction in cost (\$/kA-m) of 2G HTS wire designed for commercial electric machine applications operating at ~65K in magnetic fields of ~1.5T

#### **Project Innovations:**

- A novel, double-sided HTS wire architecture with a uniformly distributed array of pinning centers
- Innovative manufacturing and cost reduction technologies

#### **Program Challenges:**

- Development of a high-yield Reel-to-Reel exfoliation process
- Development of a low-cost Reel-to-Reel ion irradiation process
- Integration into current manufacturing line

### **Relevance to US Energy Use and Efficiency:**

- This technology also supports the development of high-efficiency motors and generators operating at 30 50K, military applications (30 50K), power transmission/distribution (77K) and fusion (20K)
- Aids the transition of DOE supported technologies into US manufacturing capabilities
- Strengthens and advances a US-based technology and workforce

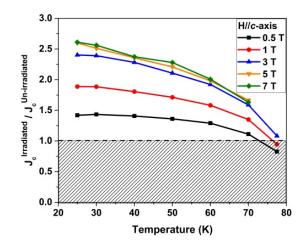
# **Technical Innovation**

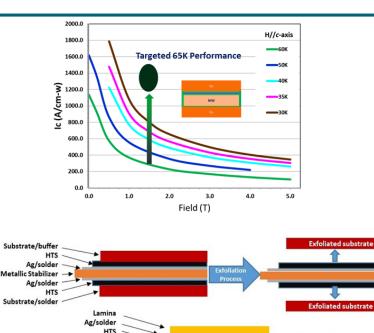
### Today's Technology

 The critical current (*I<sub>c</sub>*) in today's commercial 2G HTS wire is severely suppressed in magnetic fields at targeted operating temperatures

### **Proposed Technical Innovation:**

- *I<sub>c</sub>* can be doubled by an innovative 2-sided wire architecture
- Suppression of I<sub>c</sub> can be reduced by introduction of uniformly distributed pinning defects produced by ion irradiation





- Technologies easily integrated into existing manufacturing line
- Substantial increase in wire I<sub>c</sub> and J<sub>e</sub>
- Reduced wire cost (\$/kA-m)

Ag/solder

Ag/solder HTS Ag/solder Lamina

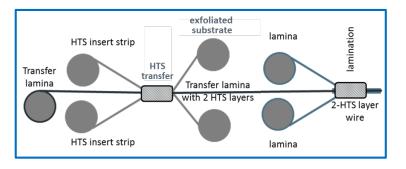
Metallic Stabilizer

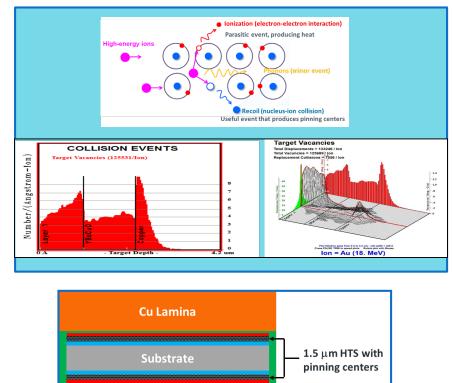
Double HTS

Layer Wire

# Technical Approach – The Innovation

- 2-sided HTS wire architecture
  - Innovative exfoliation process for transferring HTS films to both sides of a non-magnetic substrate (high J<sub>e</sub>/reduced materials/reuseable template)
- Uniform pinning sites optimized for enhanced performance in magnetic fields
  - Reel-to-reel ion irradiation (intrinsic uniformity)
  - Ion, dosage and post anneal optimized for temperature and fields of specific application
- Higher I<sub>c</sub>
  - Increased HTS layer thickness
- Technology Integration
  - Integration of 3 key innovations into a high performance, reduced-cost HTS wire





Cu Lamina

5

6

# Technical Approach – The Team

## AMSC:

Leader in development of 2G HTS wire and commercial /military applications

- State-of-the-art 2G wire technology developed with focus on cost, reproducibility and yield.
- HTS wire used in both commercial and military cable and coil applications.
- Leader in development of near-term commercial markets.
- Integration of technologies and development of high-yield, reproducible manufacturing processes

## **Brookhaven National Laboratory - Qiang Li (Partner)**

- Development of ion irradiation process and optimization for target conditions
- Characterization of pinning enhancement
- Facility for reel-to-reel pilot manufacturing

## Brookhaven Technology Group – Vyacheslav Solovyov (Partner)

- Development of exfoliation technology and supporting processes (slitting, rapid, low-temperature annealing, etc.)
- Characterization of double-sided conductor

## University of Buffalo - Amit Goyal (Partner)

• Microstructural characterization of ion induced pinning centers and HTS layers.











## **Results and Accomplishments**

500

Current ( 300

100

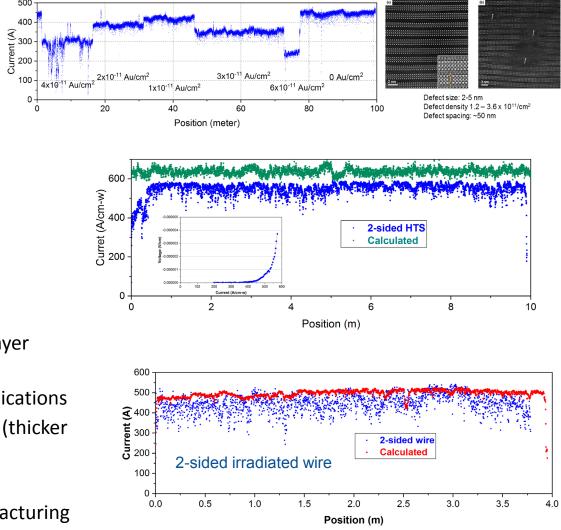
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### Project Status / Accomplishments (BP-1)

- Critical Milestones
  - Demonstrated  $I_c$  enhancement by ion irradiation for targeted temperature/field conditions
  - Fabricated double-sided HTS tape in R2R process with > 90%  $I_c$  retention
  - Demonstrated increased HTS layer thickness
  - Integrated Ion Irradiation and *Exfoliation* technologies

### Future Work BP-2/BP-3

- Validate mechanical properties of 2-layer architecture
- Optimize Irradiation for 65K.1,5T applications
- Integration of individual technologies (thicker HTS/2-sided HTS/irradiation)
- Manufacture long length wire
- Validate capability and yield of manufacturing process
- Validate wire performance in test coil



## Transition

- Commercialization Approach
  - Provide system based solutions to end users
  - Collaboration with OEM's to offer system based solutions

## Technology Sustainment

- Identify applications and establish price sensitivity (wire and system)
- Target applications based on market size and price sensitivity
- Increased manufacturing capacity will reduce wire cost and open new markets
- Target additional markets



